

Title (en)  
Creep resistant rhenium-free nickel based superalloy

Title (de)  
Kriechbeständige, rheniumfreie Nickelbasissuperlegierung

Title (fr)  
Superalliage à base de nickel sans rhénium résistant au flUAGE

Publication  
**EP 2725110 B1 20170503 (DE)**

Application  
**EP 12190156 A 20121026**

Priority  
EP 12190156 A 20121026

Abstract (en)  
[origin: EP2725110A1] The nickel-based alloy comprises 11-13 atomic% aluminum, 4-14 atomic% cobalt, 6-12 atomic% chromium, 0.1-2 atomic % molybdenum, 0.1-3.5 atomic% tantalum, 0.1-3.5 atomic% titanium, 0.1-3 atomic% tungsten, and nickel and unavoidable impurity as remainder. The nickel-based alloy consists of a matrix (gamma ) containing 50 volume% precipitated (gamma )-phase and 0.15-0.25 volume% precipitated (gamma /gamma )-phase at a temperature of 1050-1100[deg] C. The nickel-based alloy does not contain rhenium, and has a solidus temperature of more than 1320[deg] C. The nickel-based alloy comprises 11-13 atomic% aluminum, 4-14 atomic% cobalt, 6-12 atomic% chromium, 0.1-2 atomic % molybdenum, 0.1-3.5 atomic% tantalum, 0.1-3.5 atomic% titanium, 0.1-3 atomic% tungsten, and nickel and unavoidable impurity as remainder. The nickel-based alloy consists of a matrix (gamma ) containing 50 volume% precipitated (gamma )-phase and 0.15-0.25 volume% precipitated (gamma /gamma )-phase at a temperature of 1050-1100[deg] C. The nickel-based alloy does not contain rhenium, and has a solidus temperature of more than 1320[deg] C. The amount of tungsten contained in the matrix (gamma ) is higher than the amount of tungsten contained in the (gamma )-phase. An independent claim is included for article.

IPC 8 full level  
**C22C 19/05** (2006.01)

CPC (source: EP US)  
**C22C 19/056** (2013.01 - EP US); **C22C 19/057** (2013.01 - EP US); **C22F 1/10** (2013.01 - EP US); **F01D 5/28** (2013.01 - US)

Cited by  
EP3091095A1; EP2927336A1; US10487376B2

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DOCDB simple family (publication)  
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